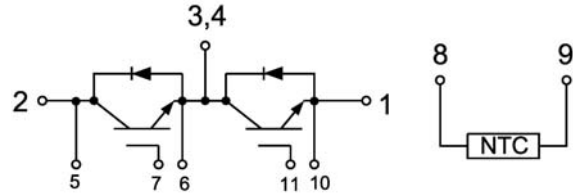


GT450HF120T9H-M

IGBT Module

Features:

- Trench & Field Stop IGBT
- Short Circuit Rated > 10 μ s
- Low Switching Loss
- 100% RBSOA Tested (2 \times I_C)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- Hybrid Electrical Vehicles (HEV)
- Automotive Applications
- Commercial Agriculture Vehicles
- Motor Drives

IGBT, Inverter Maximum Rated Values

V _{CES}	Collector-Emitter Blocking Voltage	T _J =25°C	1200	V
V _{GES}	Gate-Emitter Voltage		±20	V
I _C	Continuous Collector Current	T _C =100°C	450	A
		T _C =25°C	870	A
I _{CM}	Peak Collector Current Repetitive	t _p =1ms	900	A
t _{SC}	Short Circuit Withstand Time		>10	μs
P _D	Maximum Power Dissipation (IGBT)	T _C =25°C T _{Jmax} =175°C	2940	W

Electrical Characteristics of IGBT

Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=6mA, V_{CE}=V_{GE}, T_J=25^{\circ}C$	5.0	5.5	6.6	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=450A, V_{GE}=15V$	$T_J=25^{\circ}C$		1.70	1.90	V
			$T_J=125^{\circ}C$		1.90		V
			$T_J=150^{\circ}C$		2.00		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0V, V_{CE}=V_{CES}, T_J=25^{\circ}C$			1	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=\pm 20V, V_{CE}=0V, T_J=25^{\circ}C$			800	nA	
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V, f=100kHz, T_J=25^{\circ}C$		35.81		nF	
C_{oes}	Output Capacitance			2.63		nF	
C_{res}	Reverse Transfer Capacitance			1.29		nF	

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=450A, R_{Gon}=1\Omega, V_{GE}=\pm 15V, \text{Inductive Load}$	$T_J=25^{\circ}C$		0.44		μs
			$T_J=125^{\circ}C$		0.45		
			$T_J=150^{\circ}C$		0.47		
t_r	Rise Time		$T_J=25^{\circ}C$		0.15		μs
			$T_J=125^{\circ}C$		0.16		
			$T_J=150^{\circ}C$		0.16		
$t_{d(off)}$	Turn-off Delay Time		$T_J=25^{\circ}C$		0.44		μs
			$T_J=125^{\circ}C$		0.46		
			$T_J=150^{\circ}C$		0.48		
t_f	Fall Time	$T_J=25^{\circ}C$		0.12		μs	
		$T_J=125^{\circ}C$		0.17			
		$T_J=150^{\circ}C$		0.18			
E_{on}	Turn-on Switching Loss	$V_{CC}=600V, I_C=450A, R_{Gon}=1\Omega, V_{GE}=\pm 15V, di/dt=2340A/\mu s (T_J=150^{\circ}C) \text{ Inductive Load}$	$T_J=25^{\circ}C$		16.5		mJ
		$T_J=125^{\circ}C$		24.5			
		$T_J=150^{\circ}C$		26.5			

E _{off}	Turn-off Switching Loss	V _{CC} =600V, I _C =450A, R _{Goff} =1Ω, V _{GE} = ±15V, du/dt=3190V/μs (T _J =150°C) Inductive Load	T _J =25°C	45.9	mJ
			T _J =125°C	58.9	
			T _J =150°C	62.5	
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C	2.34	uC
R _{g internal}	Internal Gate Resistance		T _J =25°C	1.67	Ω
RBSOA	I _C =900A, V _{CC} =1050V, V _p =1200V, R _{Goff} = 1Ω, V _{GE} =+15V to 0V, T _J =150°C		Trapezoid		
I _{SC}	SC Data	V _{CC} =600V tp=10us V _{GE} =±15V, R _{Gon} =1ohm, R _{Goff} =1ohm, T _J =150°C		2280	A
R _{θJC}	IGBT Thermal Resistance: Junction-To-Case(per leg)			0.051	°C/W

Maximum Rated Values of Diode

V _{RRM}	Repetitive Peak Reverse Voltage	T _J =25°C	1200	V
I _F	Diode Continuous Forward Current		450	A
I _{FM}	Diode Maximum Forward Current	tp=1ms	900	A
I ² t	I ² t - Value	V _R =0V, t _p =10ms, T _J =125°C	36500	A ² s
		V _R =0V, t _p =10ms, T _J =150°C	29000	A ² s

Electrical Characteristics of Diode

Symbol	Description	Conditions	Min	Typ	Max	Unit
V _{FM}	Forward Voltage	I _F =450A	T _J =25°C	1.50		V
			T _J =125°C	1.50		
			T _J =150°C	1.50		
t _{rr}	Reverse Recovery Time	I _F =450A, -diF/dt=2610A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	0.45		μs
			T _J =125°C	0.65		
			T _J =150°C	0.74		
I _{rr}	Peak Reverse Recovery Current	I _F =450A, -diF/dt=2610A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	305		A
			T _J =125°C	352		
			T _J =150°C	366		

Q _{rr}	Reverse Recovery Charge	I _F =450A, -diF/dt=2610A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	72	μC
			T _J =125°C	114	
			T _J =150°C	132	
E _{rec}	Reverse Recovery Energy		T _J =25°C	35.1	mJ
			T _J =125°C	56.3	
			T _J =150°C	64.7	
R _{θJC}	Diode Thermal Resistance: Junction-To-Case (per leg)			0.097	°C/W

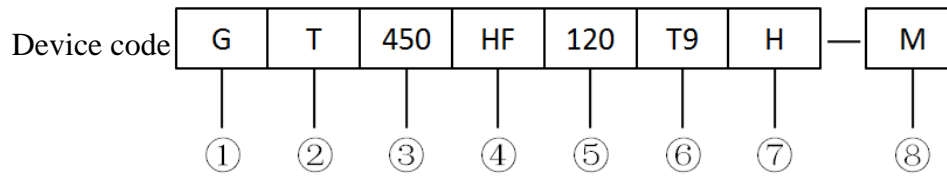
Internal NTC-Thermistor Characteristics

R ₂₅	T _C =25°C	5		kΩ
ΔR/R	T _C =100°C, R ₁₀₀ =481Ω		±5	%
P ₂₅	T _C =25°C	50		mW
B _{25/50}	R ₂ =R ₂₅ exp[B _{25/50} (1/T ₂ -1/(298.15K))]	3380		K
B _{25/80}	R ₂ =R ₂₅ exp[B _{25/80} (1/T ₂ -1/(298.15K))]	3440		K

Module

Symbol	Description	Min	Typ	Max	Unit
V _{iso}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500		V
L _{sCE}	Stray Inductance Module			20	nH
T _J	Maximum Junction Temperature			175	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40	+150	°C
T _{stg}	Storage Temperature		-40	+125	°C
CTI	Comparative Tracking Index		200		
R _{θCS}	Case-To-Sink Thermally (Conductive Grease Applied)			0.02	°C/W
M	Power Terminals Screw:M5		3.0	5.0	N·m
M	Mounting Screw:M6		4.0	6.0	N·m
G	Weight			330	g

Ordering Information Table



- ① - IGBT Module
- ② - Field Stop Trench Gate IGBT
- ③ - Rated Current (450=450A)
- ④ - Circuit Configuration (Half Bridge)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)
- ⑧ - Internal Control Code

SilverMicro

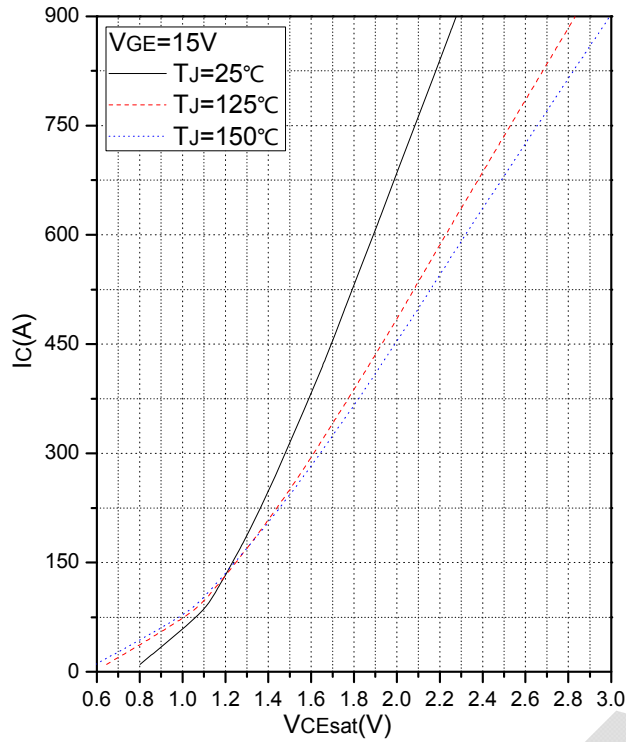


Fig.1 Typical Saturation Voltage Characteristics

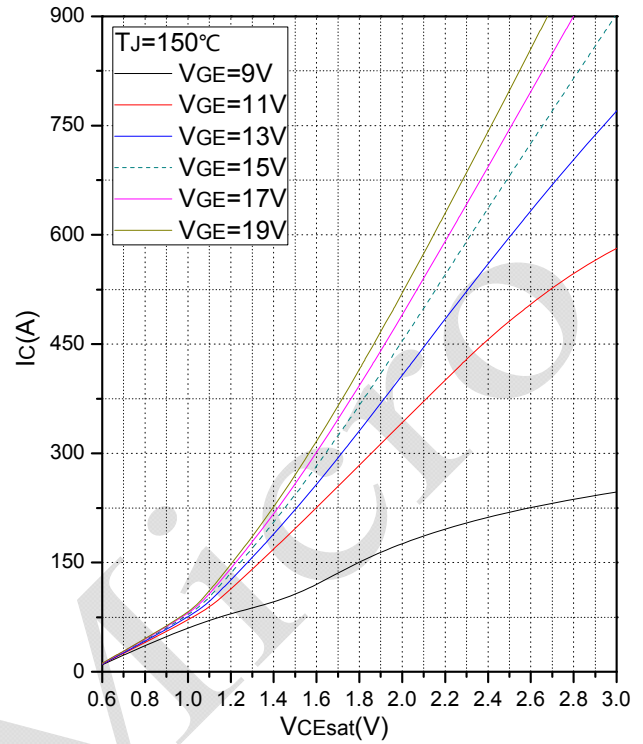


Fig.2 Typical Output Characteristics

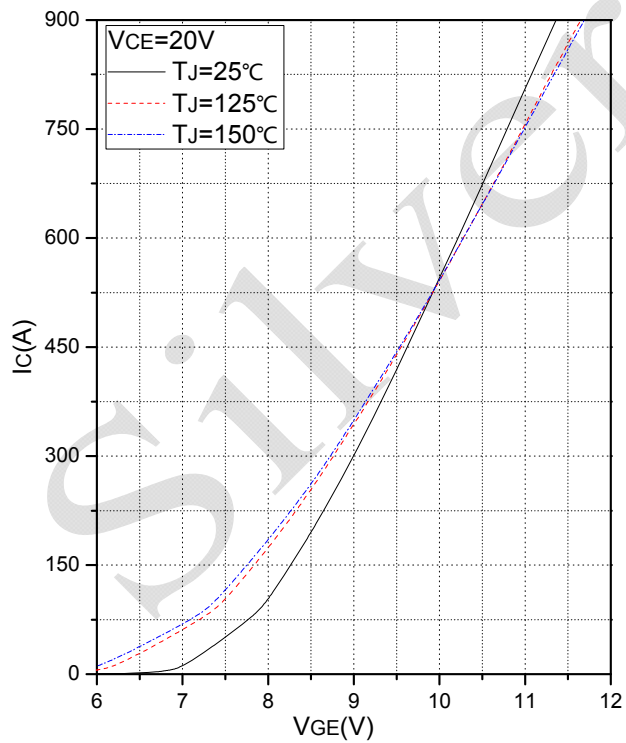


Fig.3 Transfer Characteristic

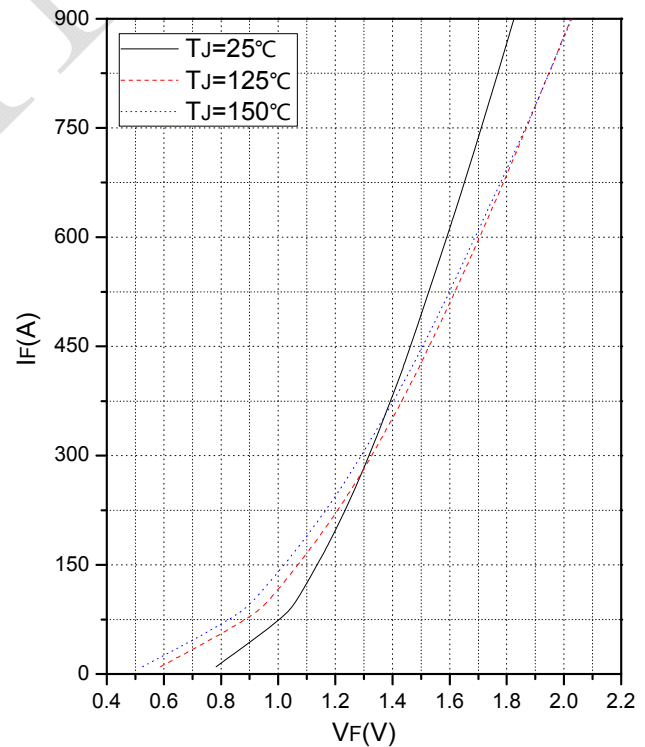


Fig.4 Forward Characteristics of Diode

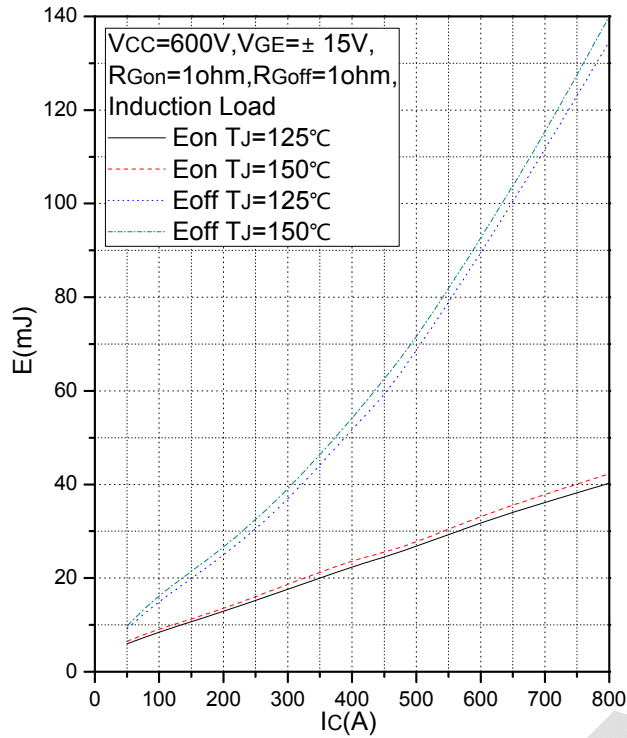


Fig.5 Typical Switching Loss vs. Collector Current

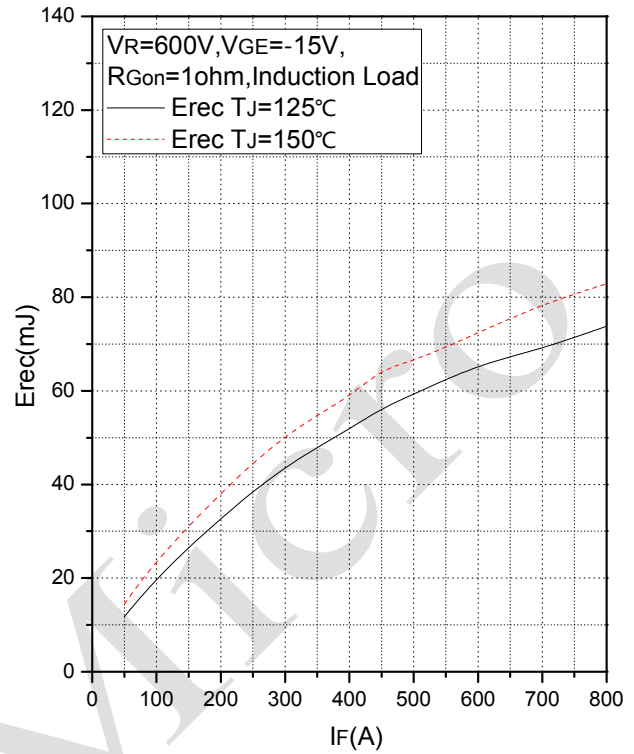


Fig.6 Typical Switching Loss vs. Forward Current

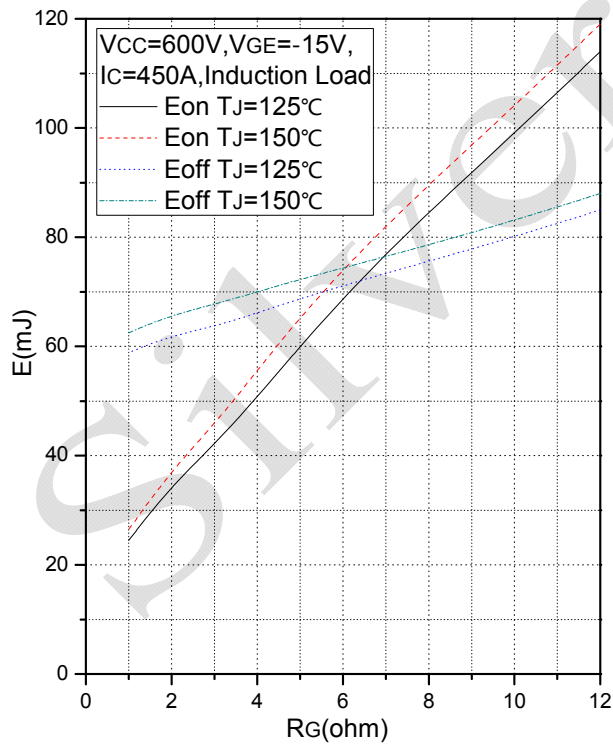


Fig.7 Typical Switching Loss vs. Gate Resistance

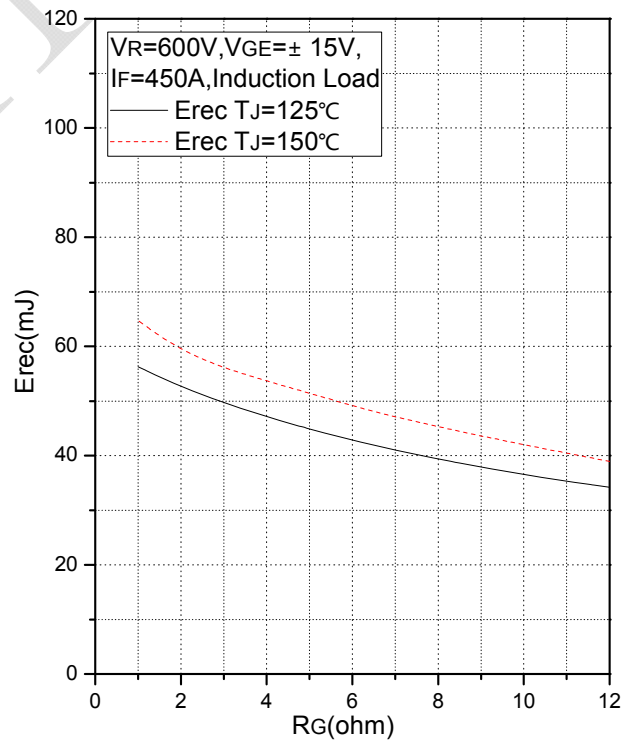


Fig.8 Typical Switching Loss vs. Gate Resistance

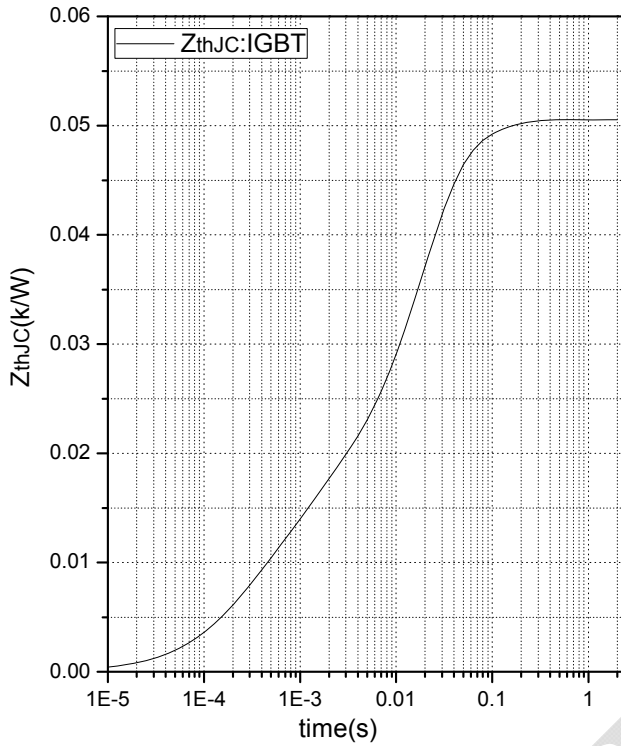


Fig.9 Transient Thermal Impedance (IGBT)

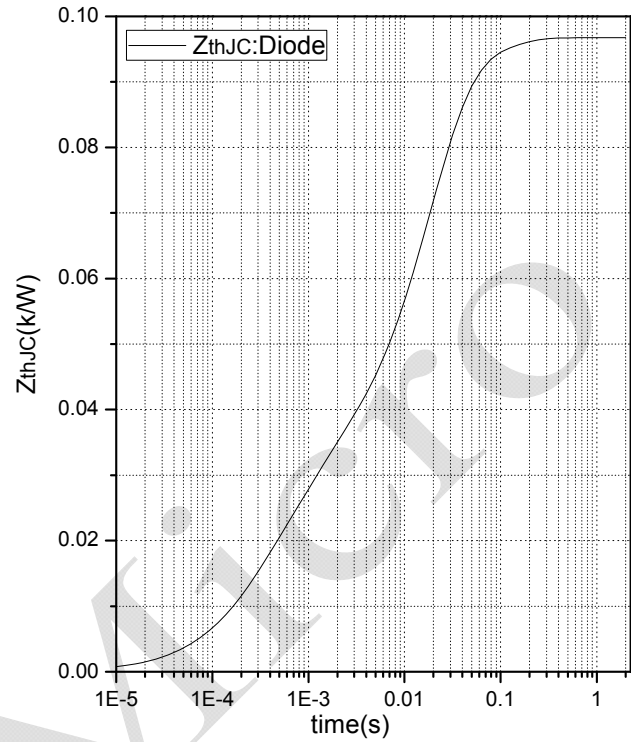


Fig.10 Transient Thermal Impedance (Diode)

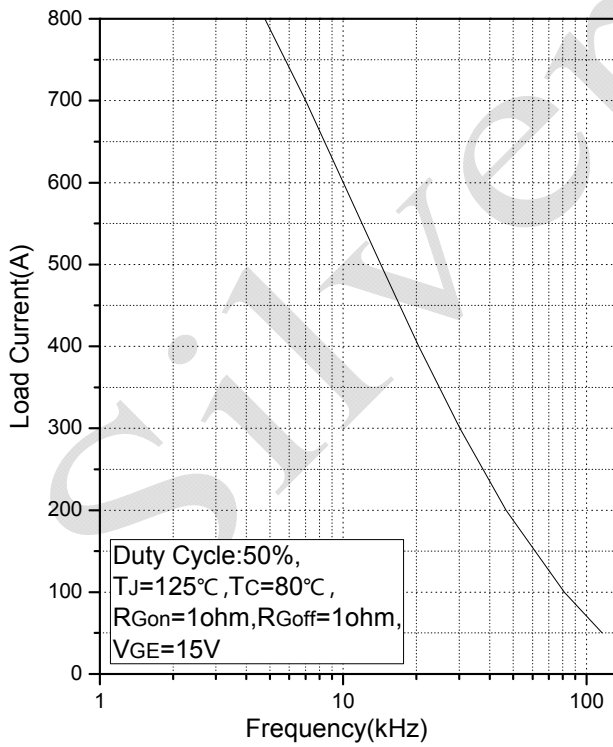


Fig.11 Typical Load Current vs. Frequency

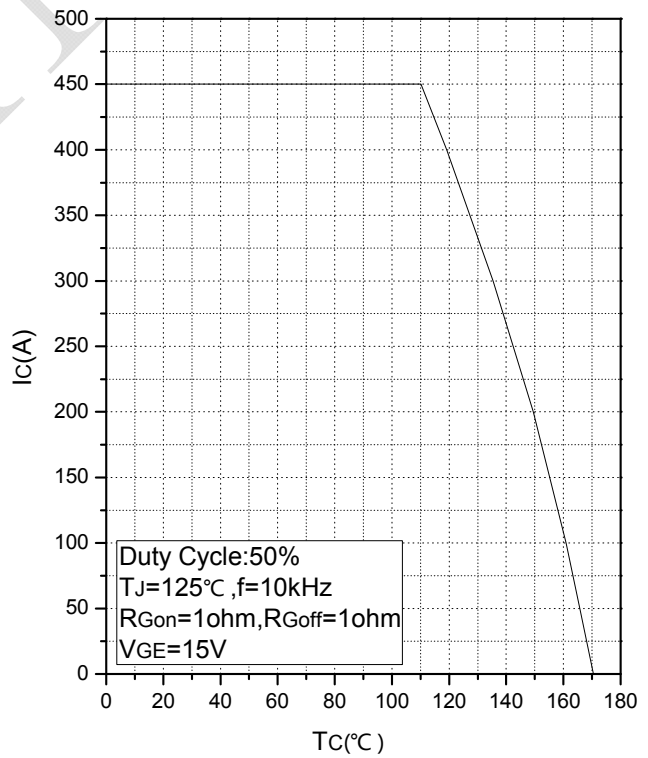


Fig.12 Rated Current vs. Temperature

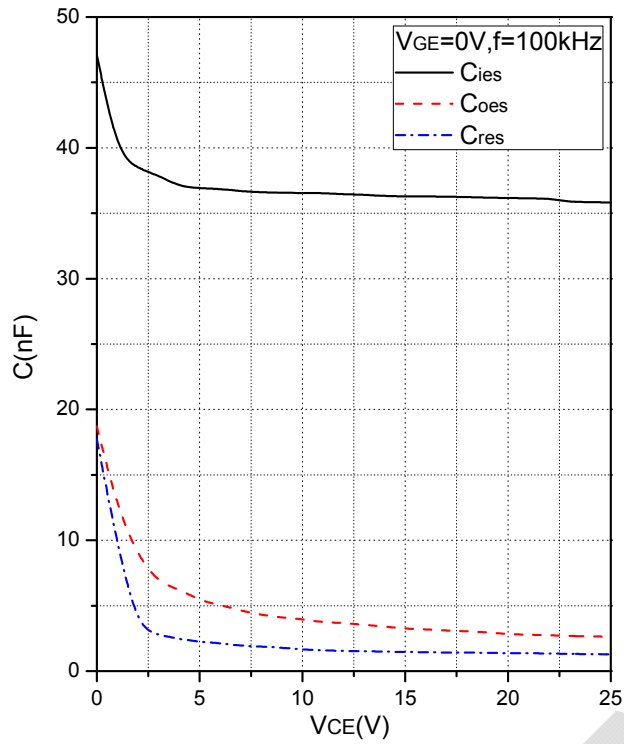


Fig.13 Capacitance Characteristics

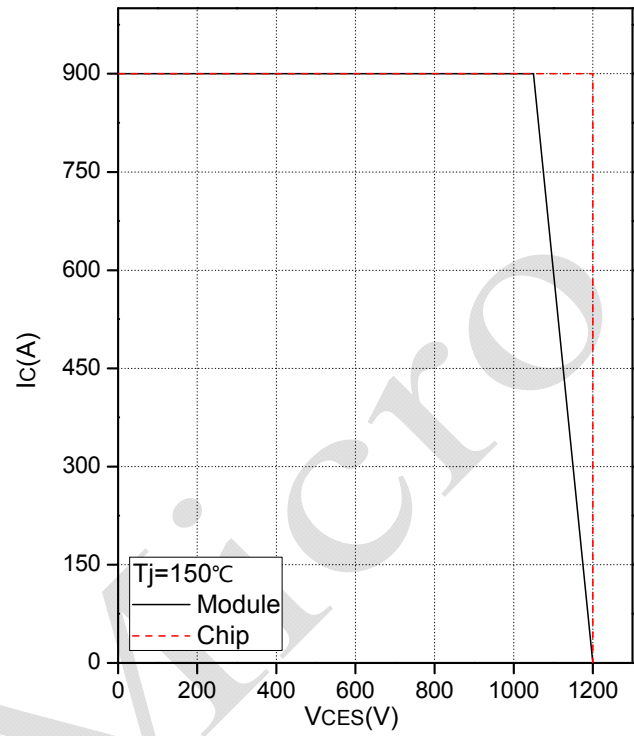


Fig.14 Reverse Bias Safe Operation Area (RBSOA)

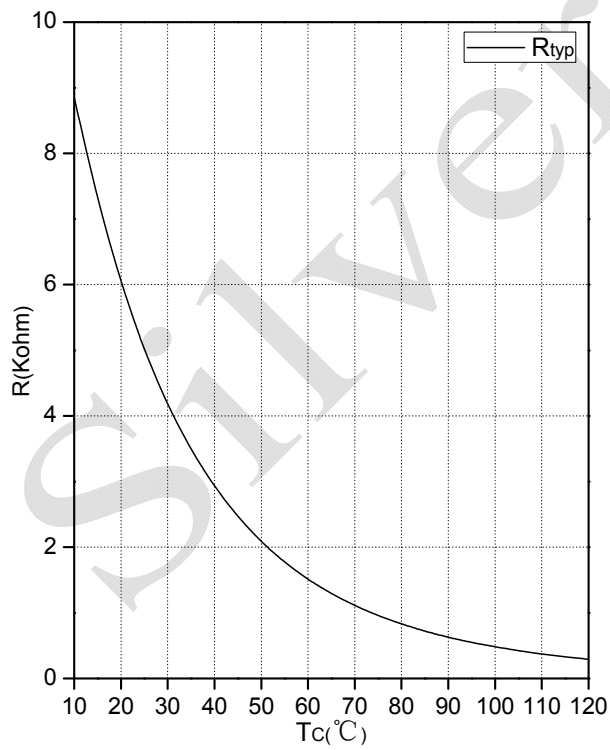
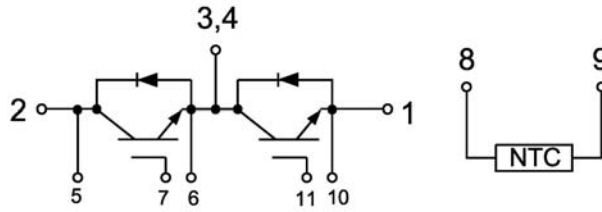
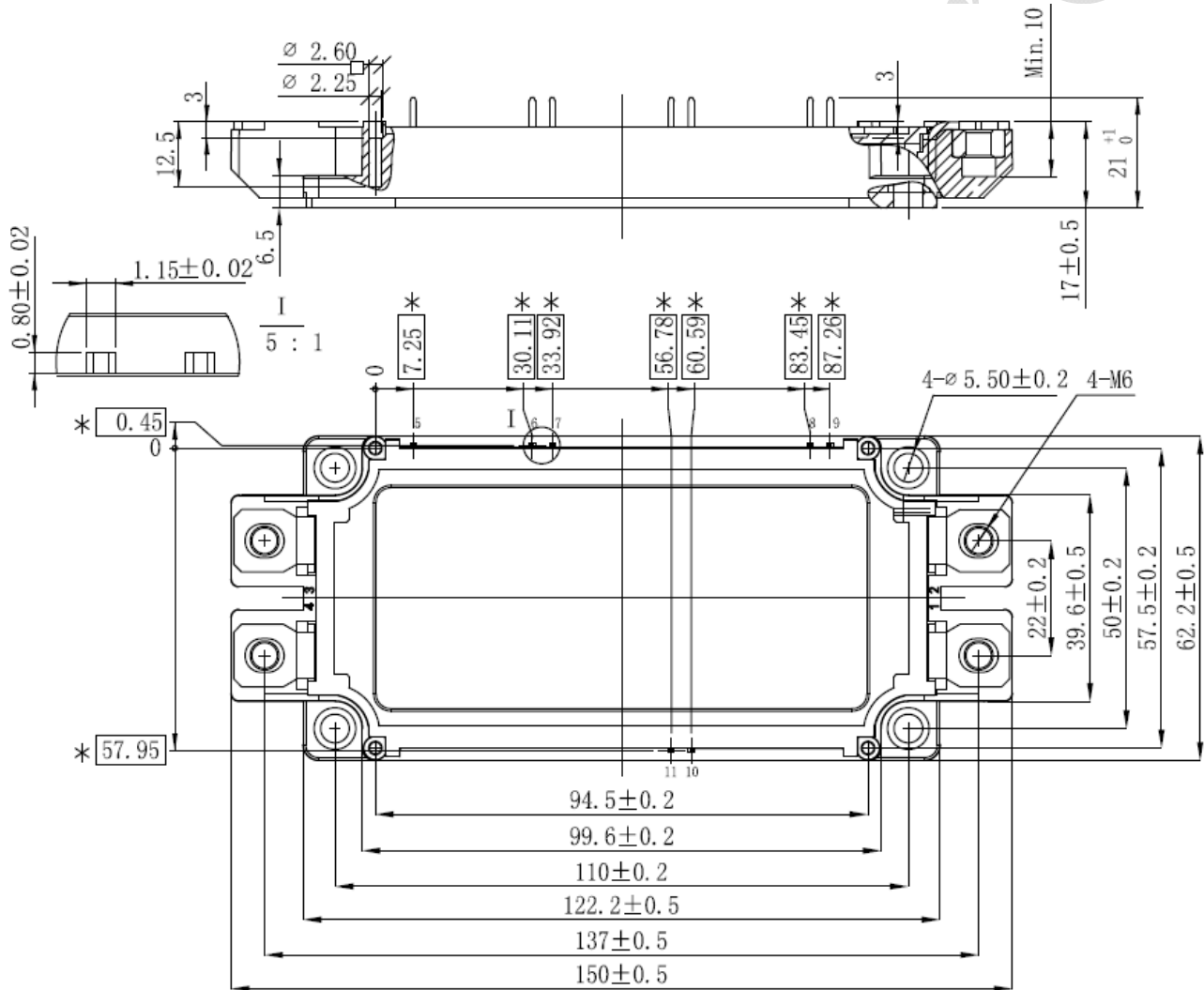


Fig.15 NTC Temperature Characteristics

Internal Circuit:



Package Outline (Unit: mm):



Date	Revision	Notes
11/29/2017	01	Initial Release
01/21/2019	02	Add Test Data @T _J =150°C
08/11/2022	A	Final Version

Announcement

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